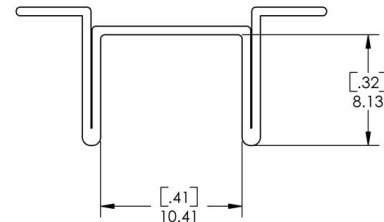
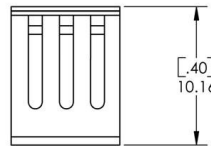
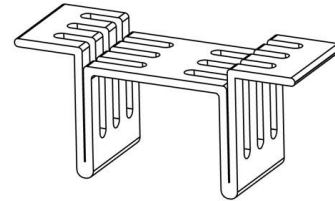
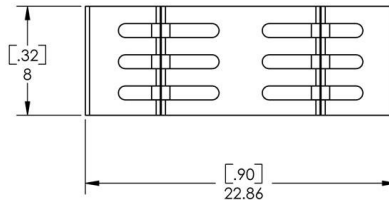
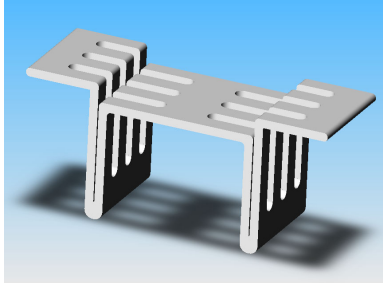


Board Level Heat Sinks



ThermaFlo

P/N: 834100T00000 & 8341TRT00000



PRODUCT SPECIFICATIONS

- Devices: D PAK, TO-252
- Size: 22.9 x 8.0 x 10.2 mm
- Material: Copper, 0.6 mm Thick
- Type: Stamped
- PCB Mounting: Surface Mount Technology
- Finish: Tin Plate
- Package: Bulk or Tape & Reel

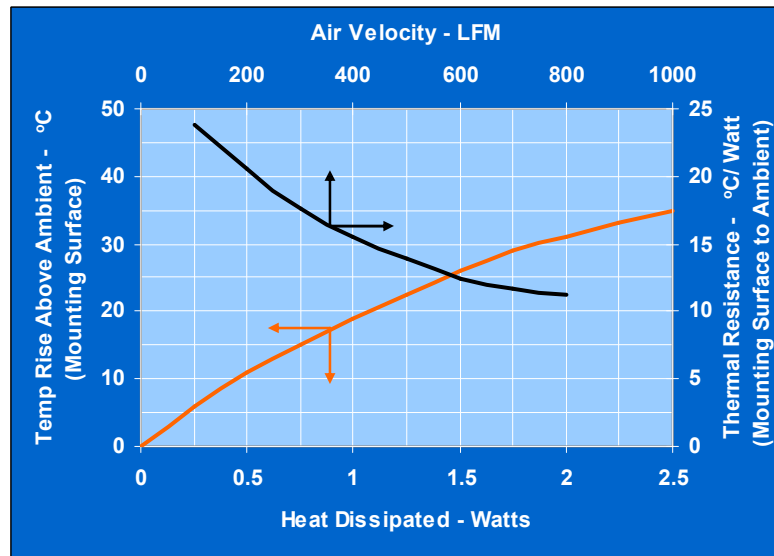
FEATURES & BENEFITS

- No Hardware Device Attachment
- Direct SMT Contact to PCB
- Solderable Legs
- RoHS Compliant



CUSTOMIZED HEATSINKS

- Specialized Body Configurations
- Contact Applications Engineering



D PAK, TO-252

Part Number	Packaging	Notes
834100T00000	Bulk	
8341TRT00000	Tape & Reel	Contact Factory for Tape and Reel Specs

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